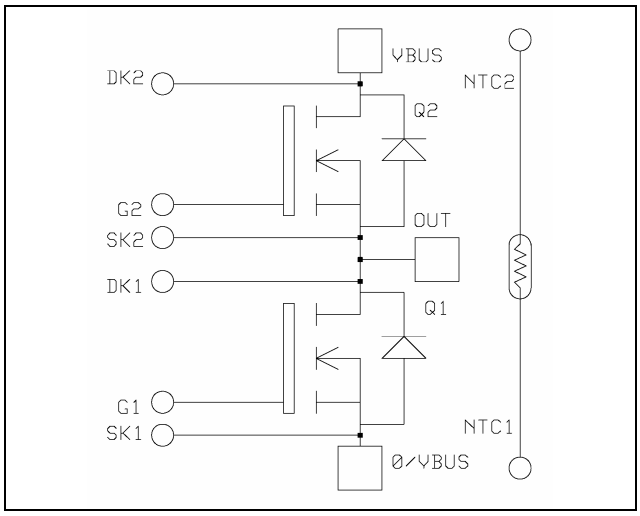
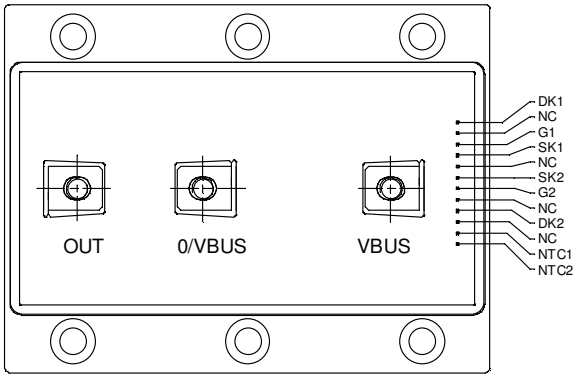
# Phase leg MOSFET Power Module

$V_{DSS}$ = 200V
$R_{DSon}$ = 5mΩ max @ Tj = 25°C
$I_D$ = 333A @ Tc = 25°C






## Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

## Features

- Power MOS V® FREDFETs
  - Low $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Fast intrinsic diode
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Kelvin Drain for VDS monitoring
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- Internal thermistor for temperature monitoring
- High level of integration

## Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals for signal and M5 for power for easy PCB mounting

## Absolute maximum ratings

| *Symbol* | *Parameter* | | *Max ratings* | *Unit* |
|---|---|---|---|---|
| $V_{DSS}$ | Drain - Source Breakdown Voltage | | 200 | V |
| $I_D$ | Continuous Drain Current | $T_c$ = 25°C | 333 | A |
| | | $T_c$ = 80°C | 249 | |
| $I_{DM}$ | Pulsed Drain current | | 700 | |
| $V_{GS}$ | Gate - Source Voltage | | ±30 | V |
| $R_{DSon}$ | Drain - Source ON Resistance | | 5 | mΩ |
| $P_D$ | Maximum Power Dissipation | $T_c$ = 25°C | 1250 | W |
| $I_{AR}$ | Avalanche current (repetitive and non repetitive) | | 333 | A |
| $E_{AR}$ | Repetitive Avalanche Energy | | 30 | mJ |
| $E_{AS}$ | Single Pulse Avalanche Energy | | 1300 | |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed.

## Electrical Characteristics

**All ratings @ $T_j$ = 25°C unless otherwise specified**

| *Symbol* | *Characteristic* | *Test Conditions* | | *Min* | *Typ* | *Max* | *Unit* |
|---|---|---|---|---|---|---|---|
| $BV_{DSS}$ | Drain - Source Breakdown Voltage | $V_{GS}$ = 0V, $I_D$ = 1mA | | 200 | | | V |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{GS}$ = 0V,$V_{DS}$ = 200V | $T_j$ = 25°C | | | 1000 | µA |
| | | $V_{GS}$ = 0V,$V_{DS}$ = 160V | $T_j$ = 125°C | | | 2500 | |
| $R_{DS(on)}$ | Drain – Source on Resistance | $V_{GS}$ = 10V, $I_D$ = 166.5A | | | | 5 | mΩ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}$ = $V_{DS}$, $I_D$ = 8mA | | 2 | | 4 | V |
| $I_{GSS}$ | Gate – Source Leakage Current | $V_{GS}$ = ±30 V, $V_{DS}$ = 0V | | | | ±250 | nA |

## Dynamic Characteristics

| *Symbol* | *Characteristic* | *Test Conditions* | *Min* | *Typ* | *Max* | *Unit* |
|---|---|---|---|---|---|---|
| $C_{iss}$ | Input Capacitance | $V_{GS}$ = 0V<br>$V_{DS}$ = 25V<br>f = 1MHz | | 40.8 | | nF |
| $C_{oss}$ | Output Capacitance | | | 9.1 | | |
| $C_{rss}$ | Reverse Transfer Capacitance | | | 3.1 | | |
| $Q_g$ | Total gate Charge | $V_{GS}$ = 10V<br>$V_{Bus}$ = 100V<br>$I_D$ = 333A | | 1184 | | nC |
| $Q_{gs}$ | Gate – Source Charge | | | 376 | | |
| $Q_{gd}$ | Gate – Drain Charge | | | 600 | | |
| $T_{d(on)}$ | Turn-on Delay Time | **Resistive Switching**<br>$V_{GS}$ = 15V<br>$V_{Bus}$ = 100V<br>$I_D$ = 333A<br>$R_G$ = 0.22 Ω | | 15 | | ns |
| $T_r$ | Rise Time | | | 25 | | |
| $T_{d(off)}$ | Turn-off Delay Time | | | 50 | | |
| $T_f$ | Fall Time | | | 10 | | |

## Source - Drain diode ratings and characteristics

| *Symbol* | *Characteristic* | *Test Conditions* | | *Min* | *Typ* | *Max* | *Unit* |
|---|---|---|---|---|---|---|---|
| $I_S$ | Continuous Source current (Body diode) | | Tc = 25°C | | | 333 | A |
| | | | Tc = 80°C | | | 249 | |
| $V_{SD}$ | Diode Forward Voltage | $V_{GS}$ = 0V, $I_S$ = - 333A | | | | 1.3 | V |
| dv/dt | Peak Diode Recovery ❶ | | | | | 8 | V/ns |
| $t_{rr}$ | Reverse Recovery Time | $I_S$ = - 333A<br>$V_R$ = 100V<br>$di_S/dt$ = 800A/µs | $T_j$ = 25°C | | | 240 | ns |
| | | | $T_j$ = 125°C | | | 420 | |
| $Q_{rr}$ | Reverse Recovery Charge | $I_S$ = - 333A<br>$V_R$ = 100V<br>$di_S/dt$ = 800A/µs | $T_j$ = 25°C | | 8 | | µC |
| | | | $T_j$ = 125°C | | 16 | | |

❶ dv/dt numbers reflect the limitations of the circuit rather than the device itself.
$I_S \le$ - 333A  di/dt ≤ 700A/µs  $V_R \le V_{DSS}$  $T_j \le$ 150°C

## Thermal and package characteristics

| *Symbol* | *Characteristic* | | | *Min* | *Typ* | *Max* | *Unit* |
|---|---|---|---|---|---|---|---|
| $R_{thJC}$ | Junction to Case | | | | | 0.1 | °C/W |
| $V_{ISOL}$ | RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz | | | 2500 | | | V |
| $T_J$ | Operating junction temperature range | | | -40 | | 150 | °C |
| $T_{STG}$ | Storage Temperature Range | | | -40 | | 125 | |
| $T_C$ | Operating Case Temperature | | | -40 | | 100 | |
| Torque | Mounting torque | To heatsink | M5 | 2 | | 3.5 | N.m |
| | | For terminals | M5 | 2 | | 3.5 | |
| Wt | Package Weight | | | | | 550 | g |

## Temperature sensor NTC

| *Symbol* | *Characteristic* | *Min* | *Typ* | *Max* | *Unit* |
|---|---|---|---|---|---|
| $R_{25}$ | Resistance @ 25°C | | 68 | | kΩ |
| $B_{25/85}$ | $T_{25}$ = 298.16 K | | 4080 | | K |

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

T: Thermistor temperature
$R_T$: Thermistor value at T

## Package outline